

## -60V P-Channel Enhancement Mode MOSFET

### 1. Product Information

#### 1.1 Features

- ◇ Surface-mounted package
- ◇ Advanced TRENCH cell design

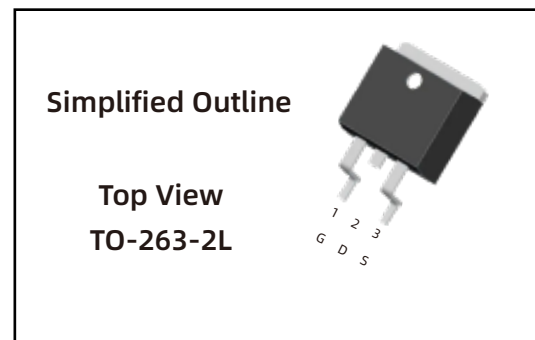
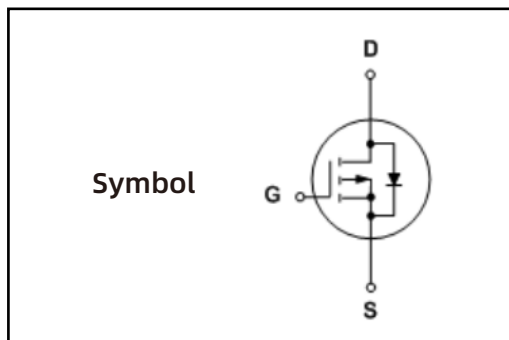
#### 1.2 Applications

- ◇ LCD TV appliances
- ◇ High power inverter system
- ◇ LCDM appliances

#### 1.3 Quick reference

- ◇  $BV \cong -60\text{ V}$
- ◇  $P_{\text{tot}} \cong 156\text{ W}$
- ◇  $I_D \cong -120\text{ A}$
- ◇  $R_{\text{DS(ON)}} \cong 6.0\text{ m}\Omega @ V_{\text{GS}} = -10\text{ V}$
- ◇  $R_{\text{DS(ON)}} \cong 7.7\text{ m}\Omega @ V_{\text{GS}} = -4.5\text{ V}$

### 2. Pin Description



### 3. Marking Information

Product Name	Marking
LN055P060K	LN055P060K CYWWZZ XXXXXX

## 4.Limiting Values

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DS}$	Drain-Source Voltage	$T_C = 25\text{ }^\circ\text{C}$	- 60	-	V
$V_{GS}$	Gate-Source Voltage	$T_C = 25\text{ }^\circ\text{C}$	-	$\pm 20$	V
$I_D^{*,**,*}$	Drain Current ( DC )	$T_C = 25\text{ }^\circ\text{C}, V_{GS} = -10\text{ V}$	-	-120	A
$I_D^*$		$T_C = 100\text{ }^\circ\text{C}, V_{GS} = -10\text{ V}$	-	- 79	A
$I_{DM}^{*,**,***}$	Drain Current ( Pulsed )	$T_C = 25\text{ }^\circ\text{C}, V_{GS} = -10\text{ V}$	-	-180	A
$P_{tot}^*$	Drain power dissipation	$T_C = 25\text{ }^\circ\text{C}$	-	156	W
$T_{stg}$	Storage Temperature		-55	150	$^\circ\text{C}$
$T_J$	Junction Temperature			150	$^\circ\text{C}$
$I_S$	Continuous-Source Current	$T_C = 25\text{ }^\circ\text{C}$	-	-120	A
$E_{AS}^*$	Single Pulsed Avalanche Energy	$V_{DD} = -50\text{ V}, L = 1.0\text{mH}$	-	648	mJ
$R_{\theta JA}^*$	Thermal Resistance- Junction to Ambient		-	62.5	$^\circ\text{C/W}$
$R_{\theta JC}^*$	Thermal Resistance- Junction to Case		-	0.8	

Notes :

- \* Surface Mounted on 1 in<sup>2</sup> pad area,  $t \leq 10\text{ sec}$
- \*\* Pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 1\%$
- \*\*\* limited by bonding wire

## 5.Ordering Code

Product Name	Package	Reel Size	Tape width	Quantity	Note
LN055P060K	TO263			800	

Note: COMTECH defines " Green " as lead-free ( RoHS compliant ) and halogen free ( Br or Cl does not exceed 900 ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500 ppm by weight; Follow IEC 61249-2-21 and IPC / JEDEC J-STD-020C )

## 6. Electrical Characteristics ( $T_A=25^\circ$ Unless Otherwise Noted )

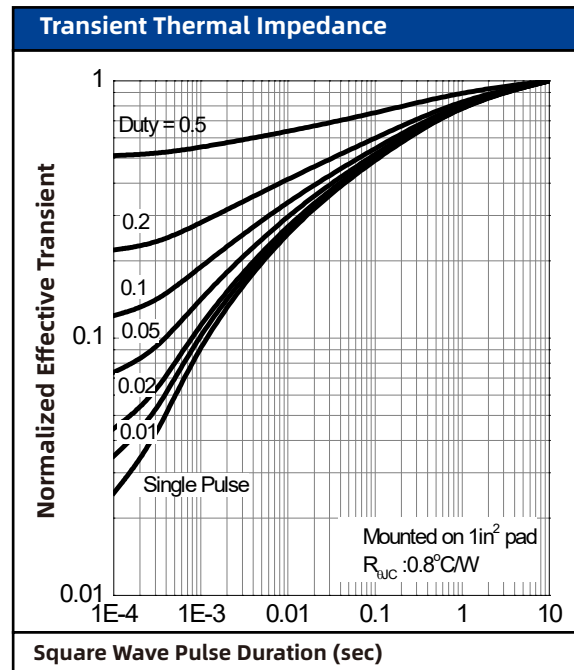
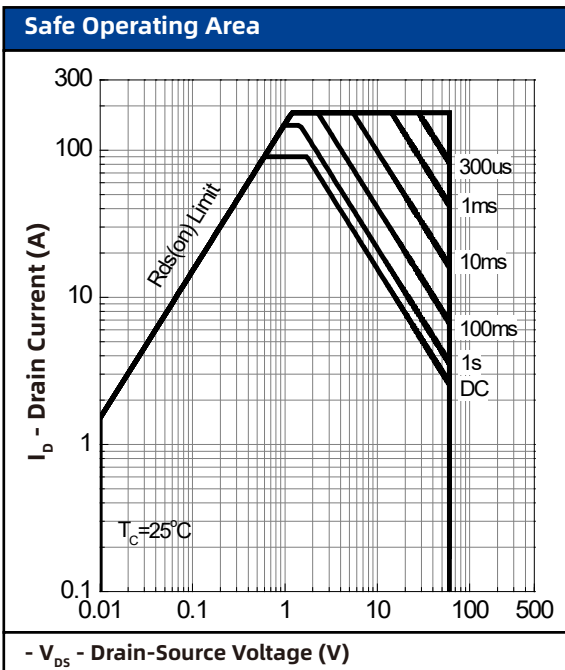
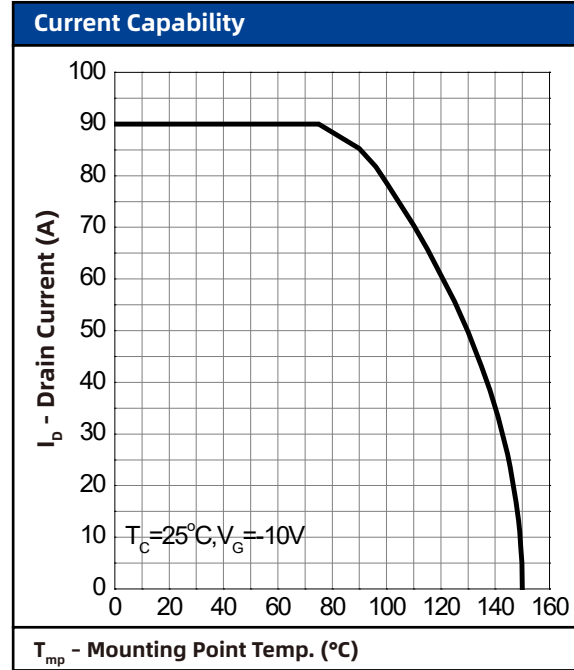
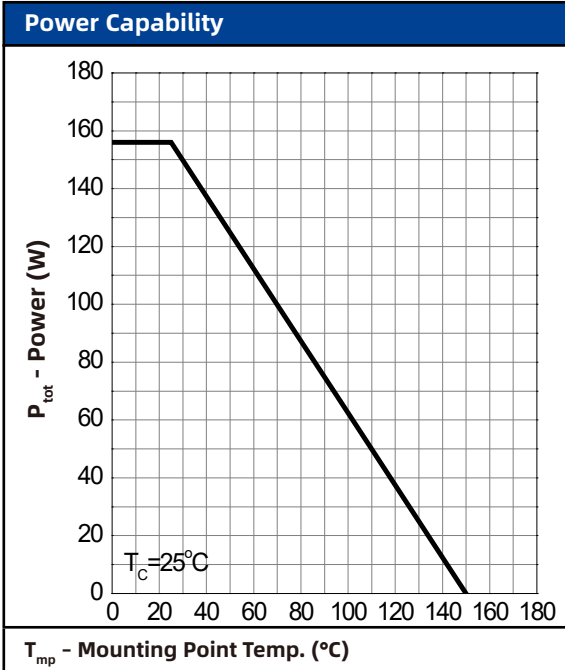
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_{DS} = -250\ \mu\text{A}$	-60	-	-	V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{DS} = -250\ \mu\text{A}$	-1	-	-2	V
$I_{DSS}$	Drain Leakage Current	$V_{DS} = -48\text{ V}, V_{GS} = 0\text{ V}$	-	-	-1	$\mu\text{A}$
$I_{GSS}$	Gate Leakage Current	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$	-	-	$\pm 100$	nA
$R_{DS(on)}^a$	On-State Resistance	$V_{GS} = -10\text{ V}, I_{DS} = -50\text{ A}$	-	5.5	6.0	m $\Omega$
		$V_{GS} = -4.5\text{ V}, I_{DS} = -30\text{ A}$	-	6.8	7.7	
<b>Diode Characteristics</b>						
$V_{SD}^a$	Diode Forward Voltage	$I_{SD} = -50\text{ A}, V_{GS} = 0\text{ V}$	-	-	-1.3	V
$t_{rr}$	Reverse Recovery Time	$I_{DS} = -50\text{ A}$	-	24	-	nS
$Q_{rr}$	Reverse Recovery Charge	$dI_{SD}/dt = 100\text{ A}/\mu\text{s}$	-	12	-	nC
<b>Dynamic Characteristics<sup>b</sup></b>						
$C_{iss}$	Input Capacitance	$V_{GS} = 0\text{ V}, V_{DS} = -30\text{ V}$ Frequency = 1 MHz	-	11842	-	pF
$C_{oss}$	Output Capacitance		-	646	-	
$C_{riss}$	Reverse Transfer Capacitance		-	193	-	
$t_d(on)$	Turn-on Delay Time	$V_{DS} = -30\text{ V}, V_{GEN} = -10\text{ V},$ $R_G = 3.9\ \Omega, R_L = 0.6\ \Omega,$ $I_{DS} = -50\text{ A}$	-	24	-	nS
$t_r$	Turn-on Rise Time		-	146	-	
$t_d(off)$	Turn-off Delay Time		-	254	-	
$t_f$	Turn-off Fall Time		-	172	-	
<b>Gate Charge Characteristics<sup>b</sup></b>						
Qg	Total Gate Charge	$V_{DS} = -30\text{ V}, V_{GS} = -10\text{ V},$ $I_{DS} = -50\text{ A}$	-	207	-	nC
Qgs	Gate-Source Charge		-	48	-	
Qgd	Gate-Drain Charge		-	33	-	

Notes :

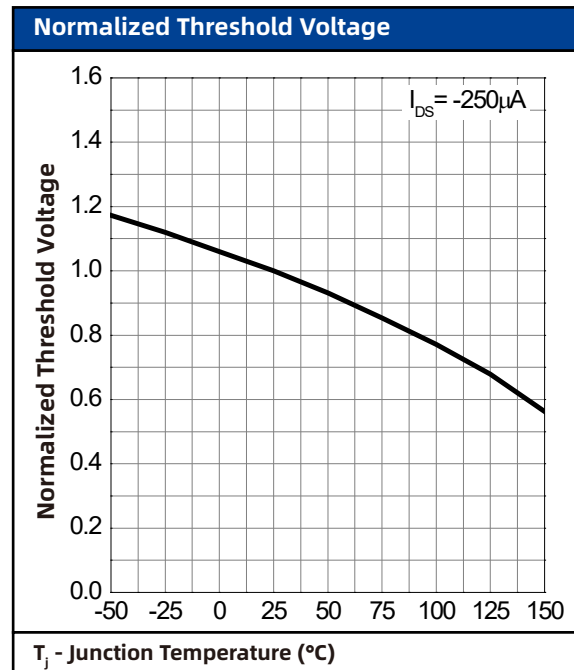
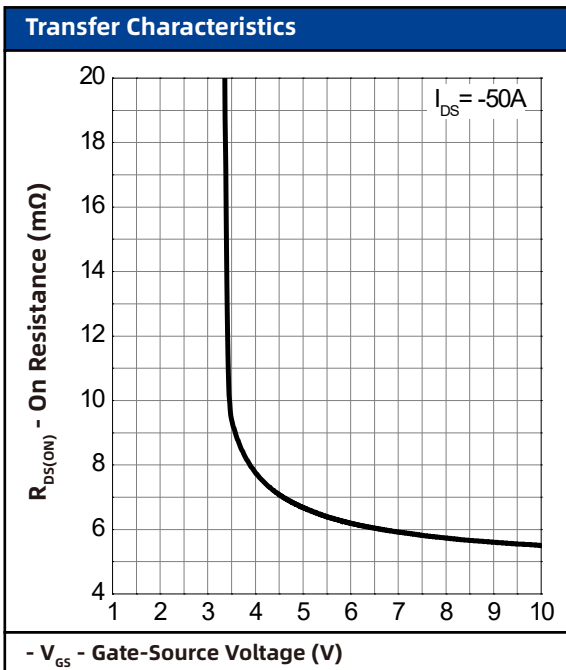
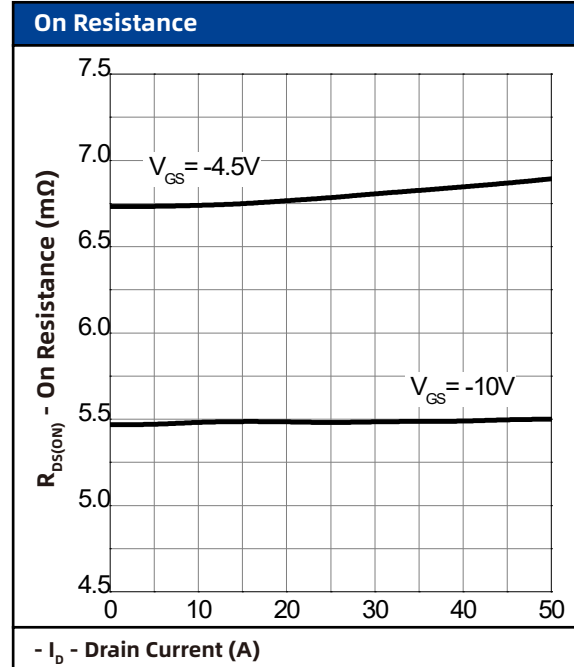
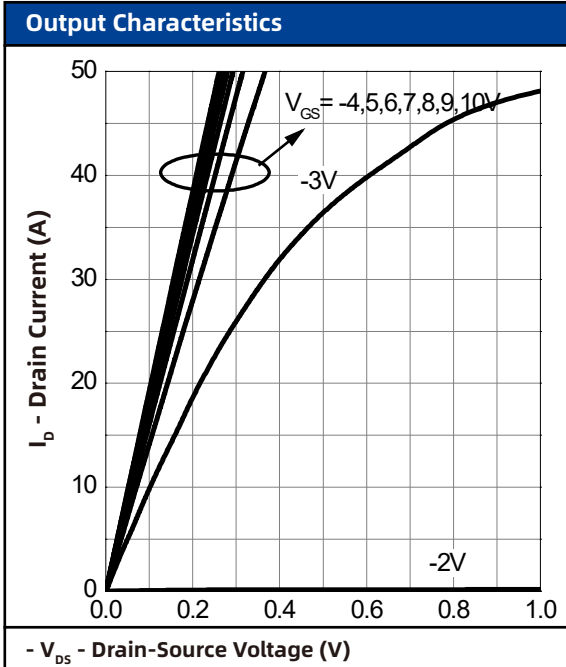
a : Pulse test ; pulse width  $\leq 300\ \mu\text{s}$ , duty cycle  $\leq 2\%$

b : Guaranteed by design, not subject to production testing

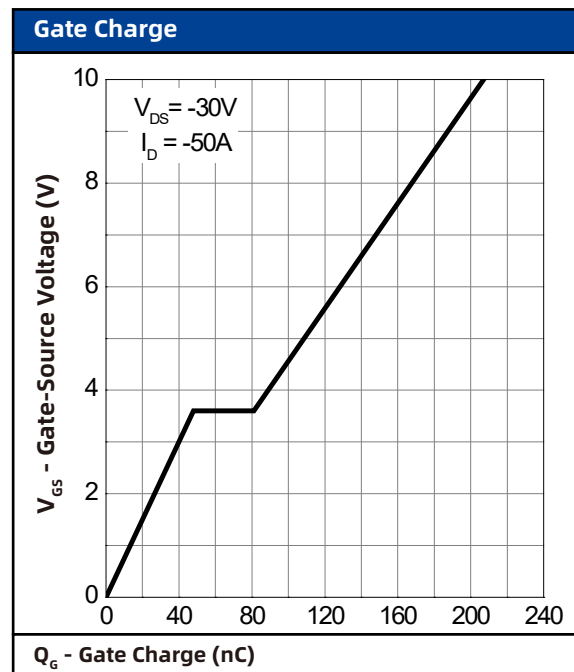
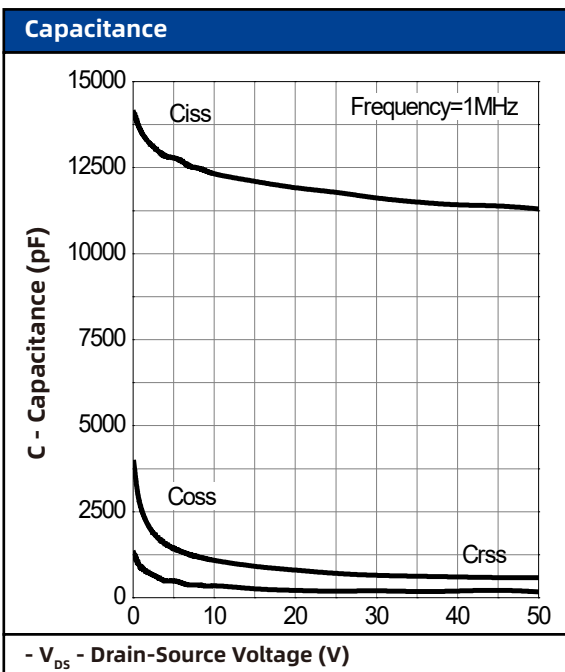
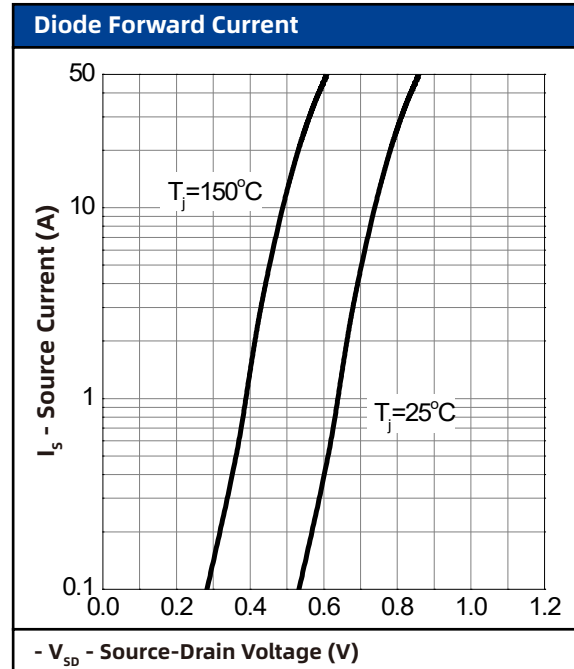
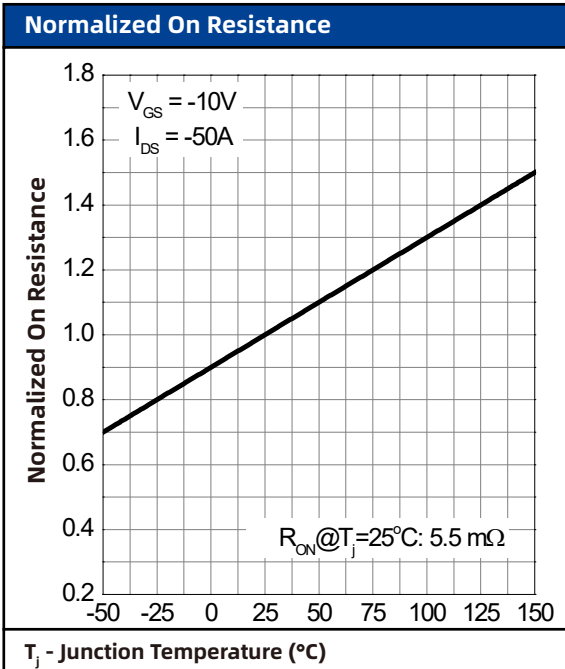
## 7. Typical Characteristics



## 7. Typical Characteristics (cont.)

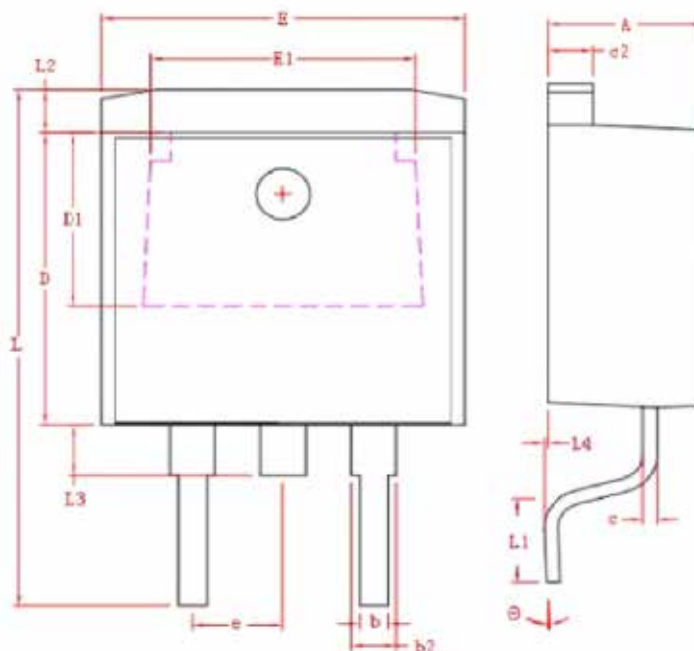


## 7. Typical Characteristics (cont.)



## 8. Package Dimensions

### T0263-2L Package



Symbol	Dimensions In Millimeters	
	MIN.	MAX.
A	4.40	4.80
b	0.76	1.00
L4	0.00	0.25
C	0.36	0.50
L3	1.50 REF	
L1	2.29	2.79
E	9.80	10.40
E1	7.40 REF	
c2	1.25	1.45
b2	1.17	1.47
D	8.60	9.00
D1	5.10 REF	
e	2.54 REF	
L	14.6	15.8
$\theta$	$0^\circ \pm 3^\circ$	
L2	1.27 REF	